

FEATURES

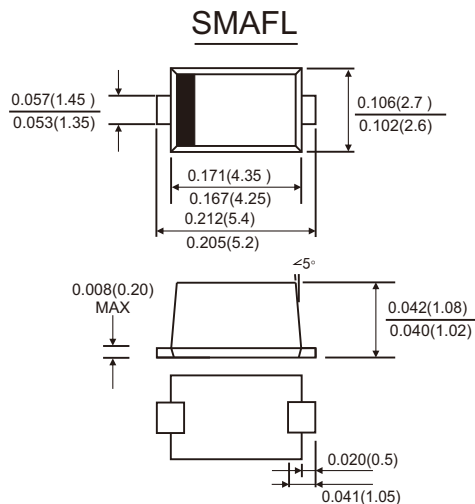
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,ultra low forward voltage drop
- High surge capability
- High temperature soldering guaranteed:260℃/10 seconds at terminals
- Component in accordance to RoHS 2011/65/EU



RoHS
COMPLIANT

MECHANICAL DATA

- Case: SMAFL molded plastic body
- Terminals: Solder Plated, solderable per MIL-STD-750,method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.0012ounce, 0.0328 gram



Dimensions in inches and (millimeters)

TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

MAXIMUM RATINGS

(Ratings at 25℃ ambient temperature unless otherwise specified)

PRIMARY CHARACTERISTICS	
$I_F(AV)$	5.0A
V_{RRM}	40V
I_{FSM}	120A
V_F at $I_F=5.0A, 25^\circ C$	0.45V
T_{JMAX}	150℃

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	40	V
Maximum average forward rectified current	$I_F(AV)$	5.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	120	A
Operating junction temperature range	T_J	-55 to+150	℃
Storage temperature range	T_{stg}	-55 to+150	℃

RATINGS AND CHARACTERISTIC OF SS54SLT

ELECTRICAL CHARACTERISTICS (TA=25℃ Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instaneous forward voltage	If=5. 0A	TA=25℃	VF 1)	0. 43	0. 45	V
		TA=100℃		0. 39	—	
		TA=125℃		0. 34	—	
	If=3. 0A	TA=25℃		0. 37	—	
		TA=100℃		0. 33	—	
		TA=125℃		0. 29	—	
Reverse current	VR=40V	TA=25℃	IR 2)	80	200	μ A
		TA=100℃		6	15	mA
		TA=125℃		20	50	
Typical junction capacitance	4V, 1MHz		CJ	310		pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle
2.Pulse test: pulse width≤40ms

THERMAL CHARACTERISTICS (TA=25℃ Unless otherwise noted)

Parameter	Symbol	SMAFL	Unit
Typical thermal resistance	RθJA 3) 4)	115	℃/W
	RθJL 3)	28	

3.Free air,mounted on recommended PCB ,2 oz.pad area
4.The heat generated must be less than thermal conductivity from junction to ambient:dPd/dtJ<1/RθJA

AVAILABLE PACK INFORMATION

Product code	Pack	Reel Size (mm)	Quantity (pcs/reel)	Box Size L×W×H (mm)	Quantity (reel/box)	Carton Size L×W×H (mm)	Quantity (box/carton)
SS54SLT-SMAFL	T/R	Φ280	5000	285×285×40	2	305×305×440	10
SS54SLT-SMAFL	T/R	Φ180	3000	185×185×80	4	305×305×440	5

RATINGS AND CHARACTERISTIC OF SS54SLT

FIG.1-FORWARD CURRENT DERATING CURVE

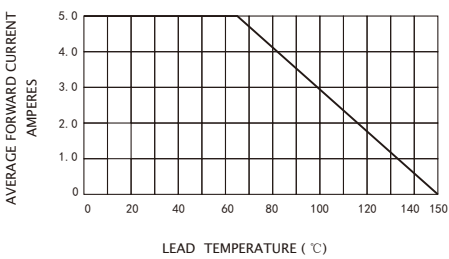


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

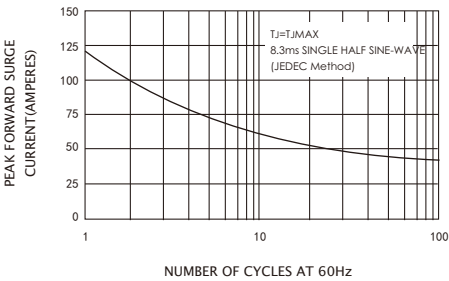


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

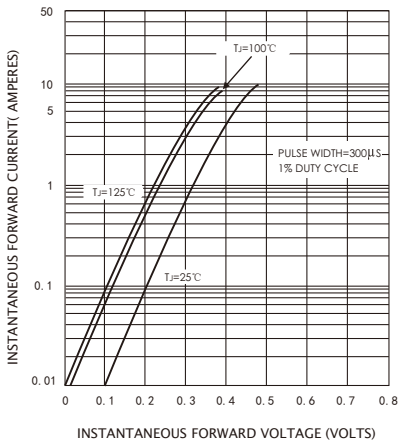


FIG.4-TYPICAL REVERSE CHARACTERISTICS

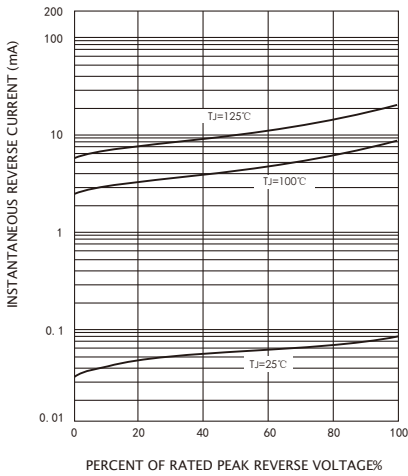


FIG.5-TYPICAL JUNCTION CAPACITANCE

